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IGBT NGTB50N60L2WG

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop (FS) Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss.

Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 5 µs Short–Circuit Capability
- These are Pb–Free Devices

Typical Applications

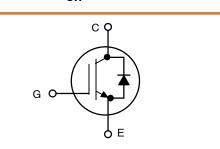
- Motor Drive Inverters
- Industrial Switching
- Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Collector-emitter Voltage	V _{CES}	600	V	
Collector Current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	Ι _C	100 50	A	
Diode Forward Current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	Ι _F	100 50	A	
Diode Pulsed Current T_{PULSE} Limited by T_{J} Max	I _{FM}	200	A	
Pulsed Collector Current, T _{pulse} Limited by T _{Jmax}	I _{CM}	200	A	
Short–circuit Withstand Time V_{GE} = 15 V, V_{CE} = 400 V, $T_J \le +150^{\circ}C$	t _{SC}	5	μs	
Gate-emitter Voltage	V _{GE}	±20	V	
Transient Gate-emitter Voltage (T _{PULSE} = 5 μs, D < 0.10)		±30	V	
Power Dissipation @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	P _D	500 250	W	
Operating Junction Temperature Range	TJ	-55 to +175	°C	
Storage Temperature Range	T _{stg}	–55 to +175	°C	
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C	

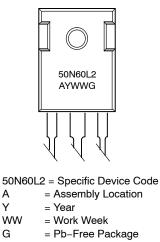
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

50 A, 600 V V_{CEsat} = 1.50 V E_{off} = 0.6 mJ





MARKING DIAGRAM



ORDERING INFORMATION

Device	Package	Shipping
NGTB50N60L2WG	TO-247 (Pb-Free)	30 Units / Rail

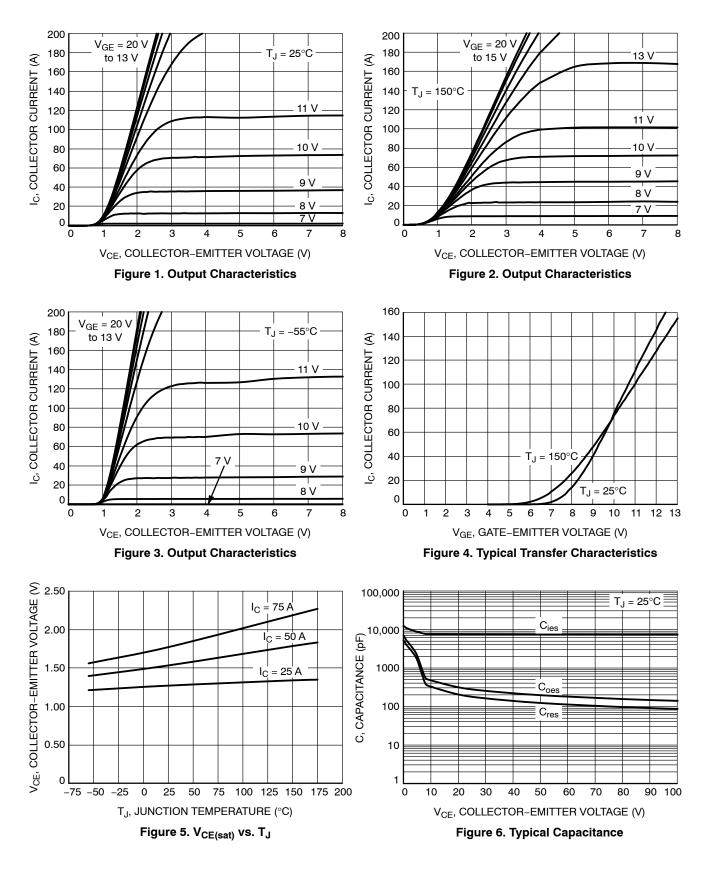
THERMAL CHARACTERISTICS

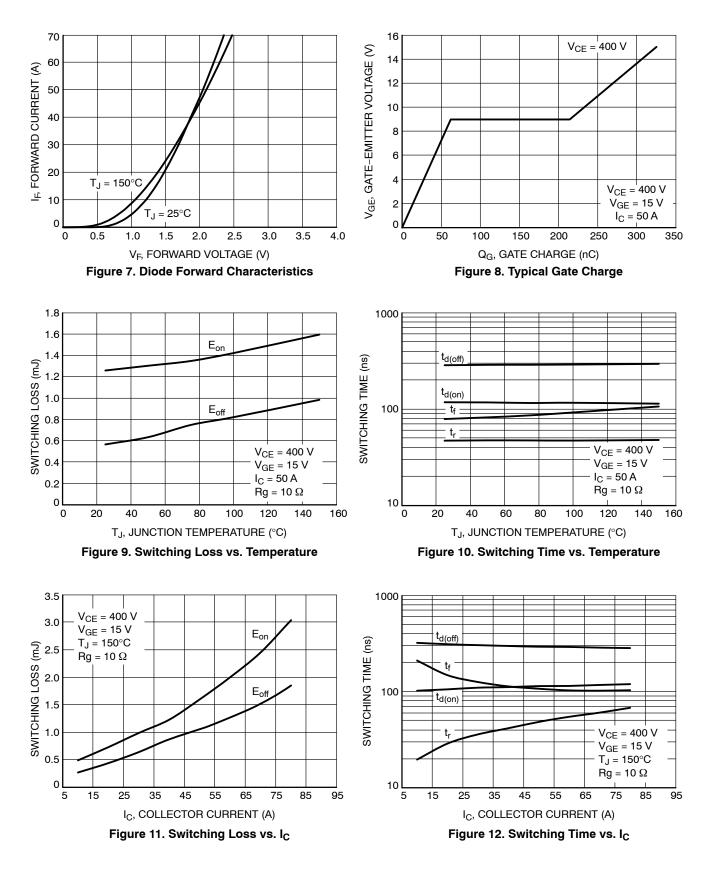
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.28	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	0.62	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

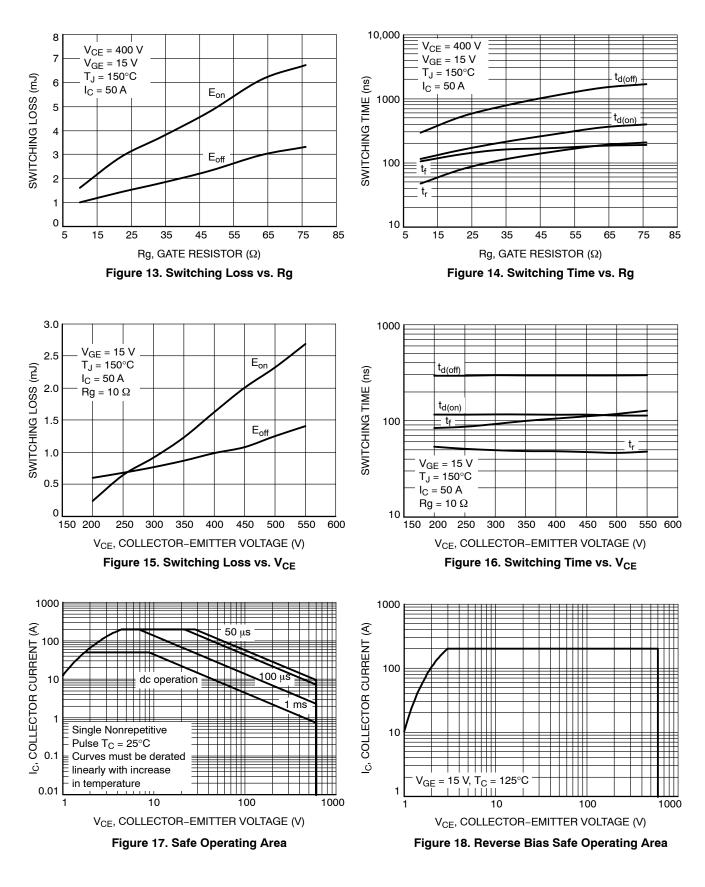
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

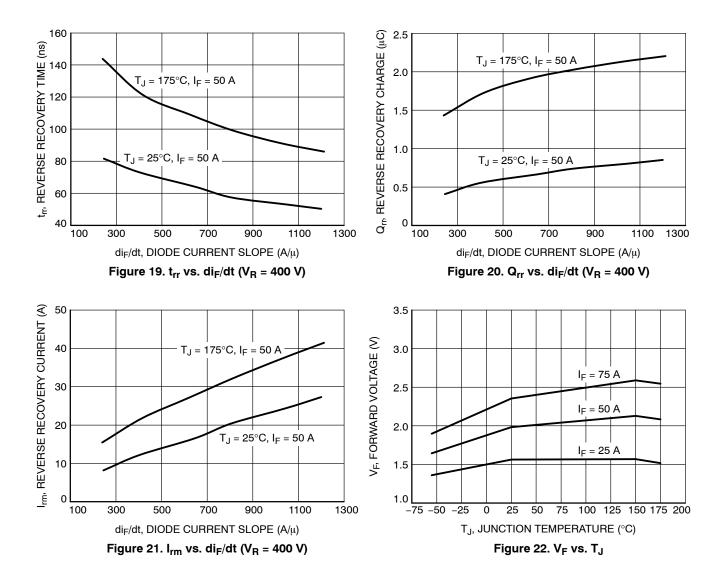
Parameter Test Conditions		Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC	·	-				
Collector-emitter breakdown voltage, gate-emitter short-circuited	V_{GE} = 0 V, I _C = 500 μ A	V _{(BR)CES}	600	_	-	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 50 A V _{GE} = 15 V, I _C = 50 A, T _J = 175°C	V _{CEsat}	1.30 -	1.50 1.85	1.80 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 350 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	V_{GE} = 0 V, V_{CE} = 600 V V_{GE} = 0 V, V_{CE} = 600 V, T_{J} = 175°C	I _{CES}		_ 1.0	0.1 4.0	mA
Gate leakage current, collector-emitter short-circuited	V _{GE} = 20 V , V _{CE} = 0 V	I _{GES}	-	-	100	nA
DYNAMIC CHARACTERISTIC						
Input capacitance		C _{ies}	-	7500	-	pF
Output capacitance	V _{CE} = 20 V, V _{GE} = 0 V, f = 1 MHz	C _{oes}	-	300	-	
Reverse transfer capacitance	1	C _{res}	-	190	-	
Gate charge total		Qg	-	310	-	nC
Gate to emitter charge	V_{CE} = 480 V, I_{C} = 50 A, V_{GE} = 15 V	Q _{ge}	-	60	-	
Gate to collector charge		Q _{gc}	-	150	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}	-	110	-	ns
Rise time	1	t _r	-	48	-	
Turn-off delay time	T _J = 25°C	t _{d(off)}	-	270	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 50 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	70	-	
Turn-on switching loss	$V_{GE} = 0 V/15 V$	Eon	-	1.25	-	mJ
Turn-off switching loss	1	E _{off}	-	0.6	-	
Total switching loss	1	E _{ts}	-	1.85	-	
Turn-on delay time		t _{d(on)}	-	115	-	ns
Rise time	1	t _r	-	50	-	
Turn-off delay time	T _J = 150°C	t _{d(off)}	-	280	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 50 \text{ A}$	t _f	-	100	-	
Turn-on switching loss	$R_g = 10 \Omega$ $V_{GE} = 0 V/15 V$	Eon	-	1.6	-	mJ
Turn-off switching loss	1	E _{off}	-	1.0	-	
Total switching loss		E _{ts}	-	2.6	-	
DIODE CHARACTERISTIC						
Forward voltage	V_{GE} = 0 V, I _F = 50 A V_{GE} = 0 V, I _F = 50 A, T _J = 175°C	V _F	1.40 -	1.70 2.40	2.50 -	V
Reverse recovery time	T _J = 25°C	t _{rr}	_	67	-	ns
Reverse recovery charge	I _F = 50 Å, V _R = 200 V	Q _{rr}	_	0.30	-	μC
Reverse recovery current	di _F /dt = 200 A/µs	I _{rrm}	_	7.4	-	Α
Reverse recovery time	TJ = 175°C	t _{rr}	-	143	-	ns
Reverse recovery charge	I _F = 50 A, V _R = 400 V	Q _{rr}	-	1.40	-	μC
Reverse recovery current	di _F /dt = 200 A/µs	I _{rrm}	_	15	_	А

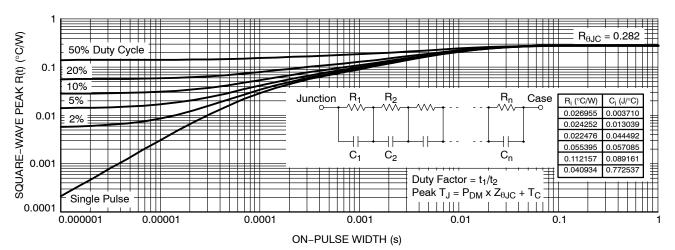
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.













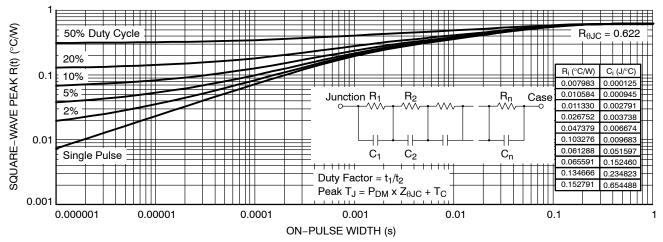
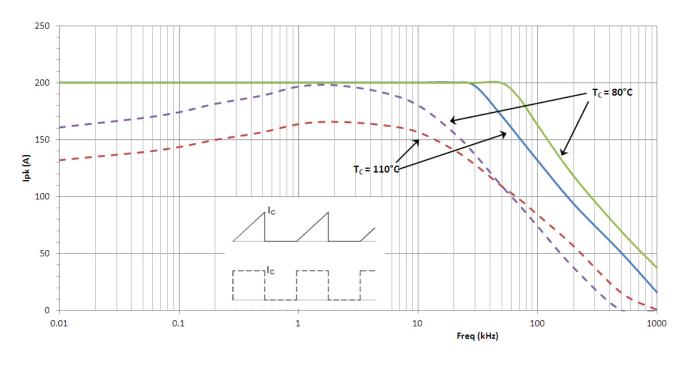


Figure 24. Diode Transient Thermal Impedance



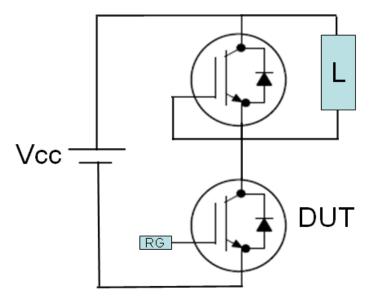
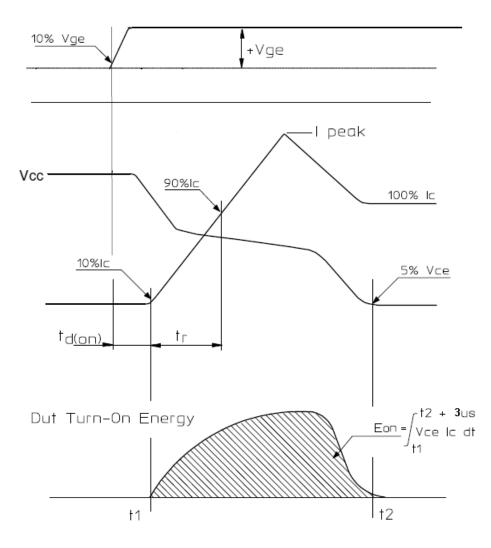
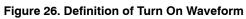


Figure 25. Test Circuit for Switching Characteristics





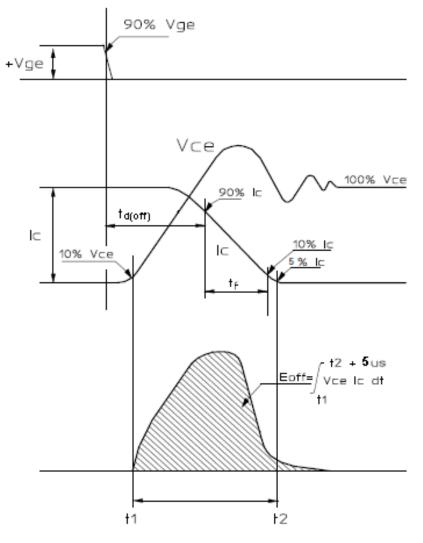
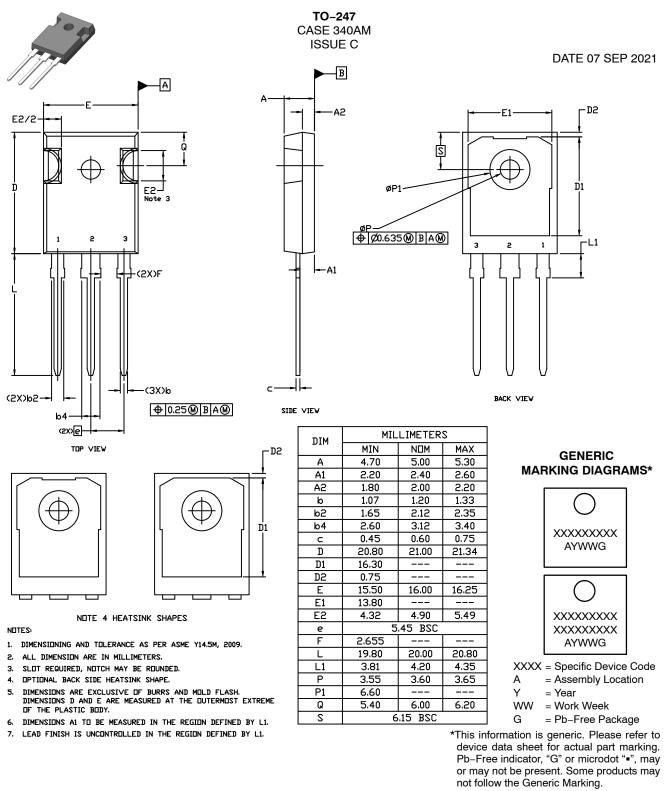


Figure 27. Definition of Turn Off Waveform

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